

SANYO Semiconductors **DATA SHEET**

LA71730EM — Monolithic Linear IC Video and Audio Signal-Processing IC

Overview

The LA71730EM is a video signal-processing system IC that handles VHS VCR formats other than SECAM. It supports the PAL (G, B, I, M, and N), NTSC-M, 4.4.3 NTSC, MESECAM, and NAP (G, B, I, M, and N) formats. Chip internal trimming is used to make this IC fully adjustment free.

This IC significantly reduces the number of peripheral components required, thus providing substantial cost savings in the signal-processing board.

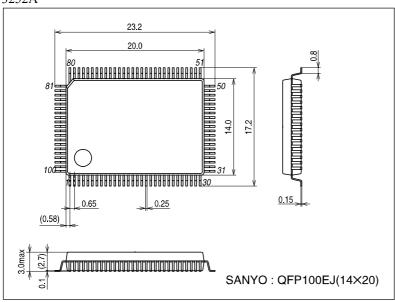
Additionally, this IC also supports the NAP standard (NTSC to PAL conversion) that is now common in Europe and China.

Features

- Multi-format VHS VCR video signal record and playback processing.
- VHS VCR audio signal record and playback processing.
- I²C bus serial control.

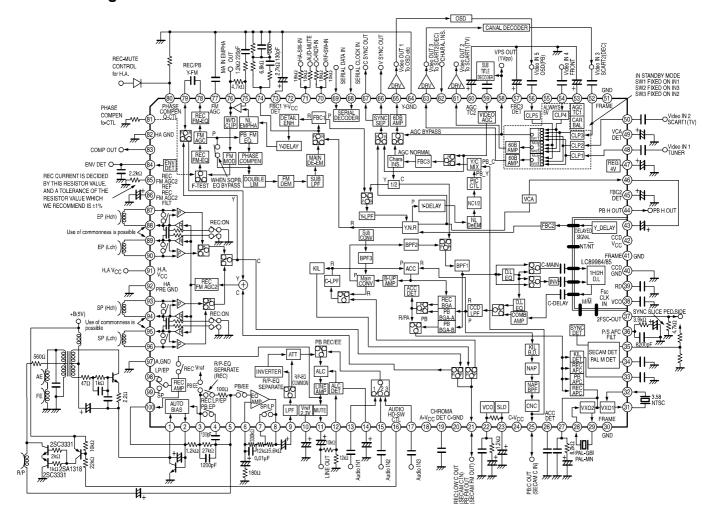
Package Dimensions

unit : mm 3252A



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Block Diagram



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